The Intersil ISL84684 device is a low ON-resistance, low voltage, bidirectional, dual single-pole/double-throw (SPDT) analog switch designed to operate from a single +1.65 V to +3.6 V supply. Targeted applications include battery powered equipment that benefits from low ron ( $0.35 \Omega$ ) and fast switching speeds ( t ON $=50 \mathrm{~ns}, \mathrm{t}_{\mathrm{OFF}}=27 \mathrm{~ns}$ ). The digital logic input is 1.8 V logic-compatible when using a single +3 V supply.

Cell phones, for example, often face ASIC functionality limitations. The number of analog input or GPIO pins may be limited and digital geometries are not well suited to analog switch performance. This part may be used to "mux-in" additional functionality while reducing ASIC design risk. The ISL84684 is offered in small form factor packages, alleviating board space limitations.

The ISL84684 is a committed dual single-pole/double-throw (SPDT) that consists of two normally open (NO) and two normally (NC) switches. This configuration can be used as a dual 2-to-1 multiplexer. The ISL84684 is pin compatible with the MAX4684 and MAX4685.
table 1. features at a glance

|  | ISL84684 |
| :---: | :---: |
| Number of Switches | 2 |
| SW | SPDT or 2-1 MUX |
| $\mathbf{3 V}$ roN | $0.35 \Omega$ |
| $\mathbf{3 V}$ toN/tOFF | $50 \mathrm{~ns} / 27 \mathrm{~ns}$ |
| $\mathbf{1 . 8 V}$ roN | $0.55 \Omega$ |
| $\mathbf{1 . 8 V}$ toN/toFF | $70 \mathrm{~ns} / 54 \mathrm{~ns}$ |
| Packages | 10 Ld 3x3 Thin DFN, 10 Ld MSOP |

## Related Literature

- Technical Brief TB363 "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices (SMDs)"
- Application Note AN557 "Recommended Test Procedures for Analog Switches"


## Features

- Drop in Replacement for the MAX4684 and MAX4685
- ON-Resistance (ron)
- V+ = +3.0V . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0.35 \Omega$
- $\mathrm{V}+=+1.8 \mathrm{~V}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0.55 \Omega$
- ron Matching Between Channels . . . . . . . . . . . . . . . . $0.055 \Omega$
- ron Flatness Across Signal Range . . . . . . . . . . . . . . . . $0.03 \Omega$
- Single Supply Operation. . . . . . . . . . . . . . . . +1.65 V to +3.6 V
- Low Power Consumption (PD) . . . . . . . . . . . . . . . $<0.2 \mu \mathrm{~W}$
- Fast Switching Action ( $\mathrm{V}+=+3.0 \mathrm{~V}$ )
- ton . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 50ns
- toff . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 27 ns
- ESD HBM Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $>8 \mathrm{kV}$
- Guaranteed Break-Before-Make
- 1.8 V Logic Compatible (+3V supply)
- Available in 10 Ld $3 \times 3$ TDFN and 10 Ld MSOP
- Pb-Free Plus Anneal Available (RoHS Compliant)


## Applications

- Battery powered, Handheld, and Portable Equipment
- Cellular/mobile Phones
- Pagers
- Laptops, Notebooks, Palmtops
- Portable Test and Measurement
- Medical Equipment
- Audio and Video Switching


## Pinout (Note 1)

## ISL84684

(10 LD TDFN, MSOP)
TOP VIEW


NOTE:

1. Switches Shown for Logic "0" Input.

## Truth Table

| LOGIC | PIN NC1 and NC2 | PIN NO1 and NO2 |
| :---: | :---: | :---: |
| 0 | ON | OFF |
| 1 | OFF | ON |

NOTE: Logic " 0 " $\leq 0.5 \mathrm{~V}$. Logic " 1 " $\geq 1.4 \mathrm{~V}$ with a 3 V supply.

## Pin Descriptions

| PIN | FUNCTION |
| :---: | :--- |
| V+ | System Power Supply Input (+1.65V to +3.6V) |
| GND | Ground Connection |
| IN | Digital Control Input |
| COM | Analog Switch Common Pin |
| NO | Analog Switch Normally Open Pin |
| NC | Analog Switch Normally Closed Pin |

## Ordering Information

| PART <br> NUMBER | PART <br> MARKING | TEMP. <br> RANGE <br> $\left({ }^{\circ} \mathrm{C}\right)$ | PACKAGE | PKG. <br> DWG. <br> \# |
| :--- | :--- | :--- | :--- | :--- |
| ISL84684IIZ-T** | $684 Z$ | -40 to +85 | 10 Ball WLCSP | W4x3.10A |
| ISL84684IR | 684 | -40 to +85 | 10 Ld 3x3 TDFN | L10.3x3A |
| ISL84684IR-T* | 684 | -40 to +85 | 10 Ld 3x3 TDFN <br> Tape and Reel | L10.3x3A |
| ISL84684IU | 4684 | -40 to +85 | 10 Ld MSOP | M10.118 |
| ISL84684IU-T* | 4684 | -40 to +85 | 10 Ld MSOP <br> Tape and Reel | M10.118 |
| ISL84684IRZ <br> (Note) | $684 Z$ | -40 to +85 | 10 Ld 3x3 TDFN <br> (Pb-free) | L10.3x3A |
| ISL84684IRZ-T* <br> (Note) | $684 Z$ | -40 to +85 | 10 Ld 3x3 TDFN <br> Tape and Reel <br> (Pb-free) | L10.3x3A |
| ISL84684IUZ <br> (Note) | $4684 Z$ | -40 to +85 | 10 Ld MSOP <br> (Pb-free) | M10.118 |
| ISL84684IUZ-T* <br> (Note) $4684 Z$ | -40 to +85 | 10 Ld MSOP <br> Tape and Reel <br> (Pb-free) | M10.118 |  |

*Please refer to TB347 for details on reel specifications.
NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100\% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb -free soldering operations. Intersil Pb -free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

| Absolute Maximum Ratings |  |
| :---: | :---: |
| V+ to GND | -0.5 to 5.5V |
| Input Voltages |  |
| NO, NC, IN (Note 2). | -0.5 to ((V+) + 0.5V) |
| Output Voltages |  |
| COM (Note 2). | -0.5 to ((V+) + 0.5V) |
| Continuous Current NO, NC, or COM | $\pm 300 \mathrm{~mA}$ |
| Peak Current NO, NC, or COM |  |
| (Pulsed 1ms, 10\% Duty Cycle, Max) . | $\ldots \pm 500 \mathrm{~mA}$ |
| ESD Rating |  |
| Human Body Model | .8kV |
| Machine Model. | .500V |
| Charged Device Model | 1.4kV |

## Thermal Information

| Thermal Resistance (Typical) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| 10 Ld 3x3 TDFN Package (Note 3) | 110 |
| 10 Ld MSOP Package (Note 3) | 190 |
| Maximum Junction Temperature (Plastic Package). | $+150^{\circ} \mathrm{C}$ |
| Maximum Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Pb-free reflow profile . . . . . . . . . . . . . . . . . . . . . . . http://www.intersil.com/pbfree/Pb-FreeReflow.asp | . .see link below |
| Operating Conditions |  |
| Temperature Range. | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:
2. Signals on NC, NO, IN, or COM exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current ratings.
3. $\theta_{\mathrm{JA}}$ is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

Electrical Specifications-3V Supply Test Conditions: $\mathrm{V}+=+2.7 \mathrm{~V}$ to $+3.3 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.4 \mathrm{~V}$ (Note 4), Unless Otherwise Specified.

| PARAMETER | TEST CONDITIONS | $\begin{aligned} & \text { TEMP } \\ & \left({ }^{\circ} \mathrm{C}\right) \end{aligned}$ | MIN <br> (Notes 5, 6) | TYP | $\begin{gathered} \text { MAX } \\ (\text { Notes 5, 6) } \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH CHARACTERISTICS |  |  |  |  |  |  |
| Analog Signal Range, V ${ }_{\text {ANALOG }}$ |  | Full | 0 | - | V+ | V |
| ON Resistance, ron | $\mathrm{V}+=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0 \mathrm{~V} \text { to } \mathrm{V}+,$ (See Figure 5) | 25 | - | 0.35 | 0.5 | $\Omega$ |
|  |  | Full | - | - | 0.7 | $\Omega$ |
| ron Matching Between Channels, $\Delta r^{\prime} \mathrm{N}$ | $\mathrm{V}+=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Voltage at max ron, (Note 8) | 25 | - | 0.055 | 0.07 | $\Omega$ |
|  |  | Full | - | - | 0.08 | $\Omega$ |
| $\mathrm{r}_{\text {ON }}$ Flatness, $\mathrm{r}_{\text {FLAT }}(\mathrm{ON})$ | $\begin{aligned} & \mathrm{V}+=2.7 \mathrm{~V}, \mathrm{I} \mathrm{ICOM}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0 \mathrm{~V} \text { to } \mathrm{V}+\text {, } \\ & (\text { Note } 7) \end{aligned}$ | 25 | - | 0.03 | 0.15 | $\Omega$ |
|  |  | Full | - | - | 0.15 | $\Omega$ |
| NO or NC OFF Leakage Current, ${ }^{\prime} \mathrm{NO}$ (OFF) or ${ }^{\mathrm{I}} \mathrm{NC}$ (OFF) | $\mathrm{V}+=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, 3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=3 \mathrm{~V}, 0.3 \mathrm{~V}$ | 25 | -4 | - | 4 | nA |
|  |  | Full | -40 | - | 40 | nA |
| COM ON Leakage Current, ICOM(ON) | $\begin{aligned} & \mathrm{V}_{+}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, 3 \mathrm{~V} \text {, or } \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V} \text {, } \\ & 3 \mathrm{~V} \text {, or Floating } \end{aligned}$ | 25 | -5 | - | 5 | nA |
|  |  | Full | -60 | - | 60 | nA |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Turn-ON Time, ton | $\mathrm{V}+=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF},$ (See Figure 1) | 25 | - | 50 | - | ns |
|  |  | Full | - | 60 | - | ns |
| Turn-OFF Time, toff | $\mathrm{V}+=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ (See Figure 1) | 25 | - | 27 | - | ns |
|  |  | Full | - | 35 | - | ns |
| Break-Before-Make Time Delay, $\mathrm{t}_{\mathrm{D}}$ | $\begin{aligned} & \mathrm{V}+=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & (\text { See Figure 3) } \end{aligned}$ | Full | - | 9 | - | ns |
| Charge Injection, Q | $\mathrm{C}_{\mathrm{L}}=1.0 \mathrm{nF}, \mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=0 \Omega$, (See Figure 2) | 25 | - | 94 | - | pC |
| OFF Isolation | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V}_{\mathrm{RMS}}, \\ & \text { (See Figure 4) } \end{aligned}$ | 25 | - | 62 | - | dB |
| Crosstalk (Channel-to-Channel) | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V}_{\mathrm{RMS}}, \\ & \text { (See Figure 6) } \end{aligned}$ | 25 | - | -85 | - | dB |
| Total Harmonic Distortion | $\mathrm{f}=20 \mathrm{~Hz}$ to $20 \mathrm{kHz}, \mathrm{V}_{\text {COM }}=2 \mathrm{~V}_{\text {P-P, }}, \mathrm{R}_{\mathrm{L}}=600 \Omega$ | 25 | - | 0.005 | - | \% |
| NO or NC OFF Capacitance, COFF | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, (See Figure 7) | 25 | - | 65 | - | pF |
| COM ON Capacitance, $\mathrm{C}_{\text {COM }}$ (ON) | $f=1 \mathrm{MHz}, \mathrm{V}_{\text {NO }}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, (See Figure 7) | 25 | - | 181 | - | pF |

## Electrical Specifications - 3V Supply

Test Conditions: $\mathrm{V}+=+2.7 \mathrm{~V}$ to $+3.3 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.4 \mathrm{~V}$ (Note 4 ), Unless Otherwise Specified.

| PARAMETER | TEST CONDITIONS | TEMP $\left({ }^{\circ} \mathrm{C}\right)$ | MIN <br> (Notes 5, 6) | TYP | MAX <br> (Notes 5, 6) | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Range |  | Full | 1.65 | - | 3.6 | V |
| Positive Supply Current, I+ | $\mathrm{V}+=+3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V}$ or $\mathrm{V}+$ | 25 | - | - | 40 | nA |
|  |  | Full | - | - | 750 | nA |
| DIGITAL INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Input Voltage Low, VINL |  | Full | - | - | 0.4 | V |
| Input Voltage High, VINH |  | Full | 1.4 | - | - | V |
| Input Current, ${ }_{\text {I }}{ }_{\text {NH, }}$, $\mathrm{I}_{\mathrm{INL}}$ | $\mathrm{V}+=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}+$ | Full | -0.5 | - | 0.5 | $\mu \mathrm{A}$ |

## Electrical Specifications - 1.8V Supply <br> Test Conditions: $\mathrm{V}+=+1.65 \mathrm{~V}$ to $+2 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=1.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.4 \mathrm{~V}$ (Note 4 ), Unless Otherwise Specified

| PARAMETER | TEST CONDITIONS | TEMP $\left({ }^{\circ} \mathrm{C}\right)$ | MIN <br> (Notes 5, 6) | TYP | MAX <br> (Notes 5, 6) | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

## ANALOG SWITCH CHARACTERISTICS

| Analog Signal Range, $\mathrm{V}_{\text {ANALOG }}$ |  | Full | 0 | - | V+ | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ON-Resistance, ron | $\begin{aligned} & \mathrm{V}+=1.65 \mathrm{~V} \text {, } \mathrm{I}_{\mathrm{COM}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0 \mathrm{~V} \text { to } \mathrm{V}+\text {, } \\ & \text { (See Figure 5) } \end{aligned}$ | 25 | - | 0.55 | - | $\Omega$ |
|  |  | Full | - | 0.6 | - | $\Omega$ |

## DYNAMIC CHARACTERISTICS

| Turn-ON Time, ton | $\begin{aligned} & \mathrm{V}+=1.65 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \text {, } \\ & \text { (See Figure 1) } \end{aligned}$ | 25 | - | 70 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Full | - | 80 | - | ns |
| Turn-OFF Time, toff | $\begin{aligned} & \mathrm{V}+=1.65 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \text {, } \\ & \text { (See Figure 1) } \end{aligned}$ | 25 | - | 54 | - | ns |
|  |  | Full | - | 65 | - | ns |
| Break-Before-Make Time Delay, $\mathrm{t}_{\mathrm{D}}$ | $\begin{aligned} & \mathrm{V}+=2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { (See Figure 3) } \end{aligned}$ | Full | - | 10 | - | ns |
| Charge Injection, Q | $\mathrm{C}_{\mathrm{L}}=1.0 \mathrm{nF}, \mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=0 \Omega$, (See Figure 2) | 25 | - | 42 | - | pC |
| OFF Isolation | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V}_{\mathrm{RMS}},$ <br> (See Figure 4) | 25 | - | 68 | - | dB |
| Crosstalk (Channel-to-Channel) | $R_{L}=50 \Omega, C_{L}=5 p F, f=100 \mathrm{kHz}, V_{C O M}=1 V_{R M S},$ (See Figure 6) | 25 | - | -95 | - | dB |
| NO or NC OFF Capacitance, C OFF | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, (See Figure 7) | 25 | - | 70 | - | pF |
| COM ON Capacitance, CCOM(ON) | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, (See Figure 7) | 25 | - | 186 | - | pF |

DIGITAL INPUT CHARACTERISTICS

| Input Voltage Low, $\mathrm{V}_{\text {INL }}$ |  | Full | - | - | 0.4 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| Input Voltage High, $\mathrm{V}_{\mathrm{INH}}$ |  | Full | 1.0 | - | - | V |
| Input Current, $\mathrm{I}_{\mathrm{INH}}, \mathrm{I}_{\mathrm{INL}}$ | $\mathrm{V}+=2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}+($ See Note 9$)$ | Full | -0.5 | - | 0.5 | $\mu \mathrm{~A}$ |

## NOTES:

4. $\mathrm{V}_{\mathrm{IN}}=$ input voltage to perform proper function.
5. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
6. Parts are $100 \%$ tested at $+25^{\circ} \mathrm{C}$. Over-temperature limits established by characterization and are not production tested.
7. Flatness is defined as the difference between maximum and minimum value of on-resistance over the specified analog signal range.
8. ron matching between channels is calculated by subtracting the channel with the highest max ron value from the channel with lowest max ron value, between NC1 and NC2 or between NO1 and NO2.
9. Limits established by characterization and are not production tested.

Test Circuits and Waveforms


Logic input waveform is inverted for switches that have the opposite logic sense.


Repeat test for all switches. $C_{L}$ includes fixture and stray capacitance.

$$
V_{\text {OUT }}=V_{(N O \text { or } N C)} \frac{R_{L}}{R_{L}+r_{O N}}
$$

FIGURE 1A. MEASUREMENT POINTS
FIGURE 1B. TEST CIRCUIT
FIGURE 1. SWITCHING TIMES


$$
\mathbf{Q}=\Delta \mathbf{V}_{\text {OUT }} \times \mathbf{C}_{\mathrm{L}}
$$

FIGURE 2A. MEASUREMENT POINTS
FIGURE 2. CHARGE INJECTION


FIGURE 3B. TEST CIRCUIT
FIGURE 3. BREAK-BEFORE-MAKE TIME

Test Circuits and Waveforms (Continued)


Signal direction through switch is reversed, worst case values are recorded. Repeat test for all switches.

FIGURE 4. OFF ISOLATION TEST CIRCUIT


Signal direction through switch is reversed; worst case values are recorded. Repeat test for all switches.

FIGURE 6. CROSSTALK TEST CIRCUIT

## Detailed Description

The ISL84684 is a bidirectional, dual single pole/double throw (SPDT) analog switch that offers precise switching capability from a single 1.65 V to 3.6 V supply with low ON-resistance ( $0.35 \Omega$ ) and high speed operation ( $\mathrm{t}_{\mathrm{ON}}=50 \mathrm{~ns}, \mathrm{t}_{\mathrm{OFF}}=27 \mathrm{~ns}$ ). The device is especially well suited for portable battery powered equipment due to its low operating supply voltage $(1.65 \mathrm{~V})$, low power consumption $(2.7 \mu \mathrm{~W}$ max), low leakage currents ( 60 nA max), and its tiny TDFN and MSOP packages. The ultra low ON-resistance and ron flatness provide very low insertion loss and distortion to applications that require signal reproduction.

## External V+ Series Resistor

For improved ESD and latch-up immunity, Intersil recommends adding a $100 \Omega$ resistor in series with the V+ power supply pin of the ISL84684 IC (see Figure 8).


Repeat test for all switches.
FIGURE 5. ron TEST CIRCUIT


Repeat test for all switches.
FIGURE 7. CAPACITANCE TEST CIRCUIT


FIGURE 8. V+ SERIES RESISTOR FOR ENHANCED ESD AND LATCH-UP IMMUNITY

During an overvoltage transient event, such as occurs during system level IEC 61000 ESD testing, substrate currents can be generated in the IC that can trigger parasitic SCR structures to turn ON, creating a low impedance path from the $\mathrm{V}+$ power supply to ground. This will result in a significant amount of current flow in the IC which can potentially create a latch-up state or permanently damage the IC. The external $V+$ resistor limits the current during this over-stress situation and has been found to prevent latch-up or destructive damage for many overvoltage transient events.

Under normal operation, the sub-microamp IDD current of the IC produces an insignificant voltage drop across the $100 \Omega$ series resistor resulting in no impact to switch operation or performance.

## Supply Sequencing and Overvoltage Protection

With any CMOS device, proper power supply sequencing is required to protect the device from excessive input currents which might permanently damage the IC. All I/O pins contain ESD protection diodes from the pin to $\mathrm{V}+$ and to GND (see Figure 9). To prevent forward biasing these diodes, $V+$ must be applied before any input signals and the input signal voltages must remain between $\mathrm{V}+$ and GND.

If these conditions cannot be guaranteed, then precautions must be implemented to prohibit the current and voltage at the logic pin and signal pins from exceeding the maximum ratings of the switch. The following two methods can be used to provide additional protection to limit the current in the event that the voltage at a signal pin or logic pin goes below ground or above the $\mathrm{V}+$ rail.

Logic inputs can easily be protected by adding a $1 \mathrm{k} \Omega$ resistor in series with the input (see Figure 9). The resistor limits the input current below the threshold that produces permanent damage and the sub-microamp input current produces an insignificant voltage drop during normal operation.

This method is not acceptable for the signal path inputs. Adding a series resistor to the switch input defeats the purpose of using a low ron switch. Connecting Schottky diodes to the signal pins as shown in Figure 9 will shunt the fault current to the supply or to ground thereby protecting the switch. These Schottky diodes must be sized to handle the expected fault current.


FIGURE 9. OVERVOLTAGE PROTECTION

## Power-Supply Considerations

The ISL84684 construction is typical of most single supply CMOS analog switches, in that they have two supply pins: V+ and GND. V+ and GND drive the internal CMOS switches and set their analog voltage limits. Unlike switches with a 4 V maximum supply voltage, the ISL84684 5.5 V maximum supply voltage provides plenty of room for the $10 \%$ tolerance of 4.3 V supplies, as well as room for overshoot and noise spikes.

The minimum recommended supply voltage is 1.65 V . It is important to note that the input signal range, switching times, and ON-resistance degrade at lower supply voltages. Refer to the "Electrical Specification" tables on page 2 and "Typical Performance Curves" on page 9 for details.

V+ and GND also power the internal logic and level shiftiers. The level shiftiers convert the input logic levels to switched V+ and GND signals to drive the analog switch gate terminals.

This family of switches cannot be operated with bipolar supplies because the input switching point becomes negative in this configuration.

## Logic-Level Thresholds

This switch family is 1.8 V CMOS compatible ( 0.5 V and 1.4 V ) over a supply range of 2.7 V to 4.5 V (see Figure 18). At 2.7 V , the $\mathrm{V}_{\mathrm{IL}}$ level is about 0.53 V . This is still above the 1.8 V CMOS guaranteed low output minimum level of 0.5 V , but noise margin is reduced.

The digital input stages draw supply current whenever the digital input voltage is not at one of the supply rails. Driving the digital input signals from GND to $\mathrm{V}+$ with a fast transition time minimizes power dissipation.

## High-Frequency Performance

In $50 \Omega$ systems, the ISL84684 has a -3dB bandwidth of 120 MHz (see Figure 19). The frequency response is very consistent over a wide $V+$ range and for varying analog signal levels.

An OFF switch acts like a capacitor and passes higher frequencies with less attenuation, resulting in signal feedthrough from a switch's input to its output. Off isolation is the resistance to this feedthrough, while crosstalk indicates the amount of feedthrough from one switch to another.
Figure 20 details the high off Isolation and crosstalk rejection provided by this part. At 100 kHz , off isolation is about 62 dB in $50 \Omega$ systems, decreasing approximately 20 dB per decade as frequency increases. Higher load impedances decrease off isolation and crosstalk rejection due to the voltage divider action of the switch OFF impedance and the load impedance.

## Leakage Considerations

Reverse ESD protection diodes are internally connected between each analog-signal pin and both $\mathrm{V}+$ and GND. One of these diodes conducts if any analog signal exceeds $\mathrm{V}+$ or GND.

Virtually all the analog leakage current comes from the ESD diodes to V+ or GND. Although the ESD diodes on a given signal pin are identical and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+ or GND and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the $V+$ and GND pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity. There is no connection between the analog signal paths and $V+$ or GND.

Typical Performance Curves $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified


FIGURE 10. ON-RESISTANCE vs SUPPLY VOLTAGE vs SWITCH VOLTAGE


FIGURE 12. ON-RESISTANCE vs SWITCH VOLTAGE


FIGURE 14. ON-RESISTANCE vs SWITCH VOLTAGE


FIGURE 11. ON-RESISTANCE vs SUPPLY VOLTAGE vs SWITCH VOLTAGE


FIGURE 13. ON-RESISTANCE vs SWITCH VOLTAGE


FIGURE 15. CHARGE INJECTION vs SWITCH VOLTAGE

Typical Performance Curves $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)


FIGURE 16. TURN-OFF TIME vs SUPPLY VOLTAGE


FIGURE 18. DIGITAL SWITCHING POINT vs SUPPLY VOLTAGE


FIGURE 20. CROSSTALK AND OFF ISOLATION


FIGURE 17. TURN-ON TIME vs SUPPLY VOLTAGE


FIGURE 19. FREQUENCY RESPONSE

## Die Characteristics

SUBSTRATE POTENTIAL (POWERED UP):
GND (QFN Paddle Connection: Tie to GND or Float)
TRANSISTOR COUNT:
114
PROCESS:
Submicron CMOS

## Wafer Level Chip Scale Package (WLCSP)



SIDE VIEW


## BOTTOM VIEW

W4x3.10A 4X3 ARRAY 10 BALL WAFER LEVEL CHIP SCALE PACKAGE

| SYMBOL | MILLIMETERS | NOTES |
| :---: | :---: | :---: |
| A | $0.64+0.05-0.10$ | - |
| A1 | $0.29 \pm 0.02$ | - |
| A2 | 0.35 REF. | - |
| b | $\theta 0.37 \pm 0.03$ | - |
| bb | $\theta 0.30$ REF. | - |
| D | $1.50 \pm 0.05$ | - |
| D1 | 1.00 BASIC | - |
| E | $2.00 \pm 0.05$ | - |
| E1 | 1.50 BASIC | - |
| SD | 0.50 BASIC | - |
| SE | 0.00 BASIC | - |
| N | 0.25 BASIC | 3 |

Rev. 1 10/05
NOTES:

1. Dimensions are in Millimeters.
2. Dimensioning and tolerancing conform to ASME 14.5M-1994.
3. Symbol " $N$ " is the actual number of solder balls.
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## Thin Dual Flat No-Lead Plastic Package (TDFN)



L10.3x3A
10 LEAD THIN DUAL FLAT NO-LEAD PLASTIC PACKAGE

| SYMBOL | MILLIMETERS |  |  | MIN |
| :---: | :---: | :---: | :---: | :---: |
|  | NOMINAL | MAX | NOTES |  |
| A | 0.70 | 0.75 | 0.80 | - |
| A1 | - | - | 0.05 | - |
| A3 | 0.20 REF |  |  | - |
| b | 0.20 | 0.25 | 0.30 | 5,8 |
| D | 2.95 | 3.0 | 3.05 | - |
| D2 | 2.25 | 2.30 | 2.35 | 7,8 |
| E | 2.95 | 3.0 | 3.05 | - |
| E2 | 1.45 | 1.50 | 1.55 | 7,8 |
| e | 0.50 BSC |  |  |  |
| k | 0.25 | - | - | - |
| L | 0.25 | 0.30 | 0.35 | 8 |
| N | 10 |  |  |  |
| Nd | 5 |  |  |  |

Rev. 3 3/06
NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. N is the number of terminals.
3. Nd refers to the number of terminals on D.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension $b$ applies to the metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip.
6. The configuration of the pin \#1 identifier is optional, but must be located within the zone indicated. The pin \#1 identifier may be either a mold or mark feature.
7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
9. Compliant to JEDEC MO-229-WEED-3 except for D2 dimensions.

Mini Small Outline Plastic Packages (MSOP)


NOTES:

1. These package dimensions are within allowable dimensions of JEDEC MO-187BA.
2. Dimensioning and tolerancing per ANSI Y14.5M-1994.
3. Dimension " $D$ " does not include mold flash, protrusions or gate burrs and are measured at Datum Plane. Mold flash, protrusion and gate burrs shall not exceed 0.15 mm ( 0.006 inch) per side.
4. Dimension "E1" does not include interlead flash or protrusions and are measured at Datum Plane. $-\mathrm{H}-\mathrm{Interlead}$ flash and protrusions shall not exceed 0.15 mm ( 0.006 inch) per side.
5. Formed leads shall be planar with respect to one another within $0.10 \mathrm{~mm}(.004)$ at seating Plane.
6. " $L$ " is the length of terminal for soldering to a substrate.
7. " N " is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08 mm ( 0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07 mm ( 0.0027 inch).
10. Datums $-\mathrm{A}-$ and $-\mathrm{B}-$ to be determined at Datum plane $-\mathrm{H}-$.
11. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

## M10.118 (JEDEC MO-187BA)

 10 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | 0.037 | 0.043 | 0.94 | 1.10 | - |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | - |
| A2 | 0.030 | 0.037 | 0.75 | 0.95 | - |
| b | 0.007 | 0.011 | 0.18 | 0.27 | 9 |
| c | 0.004 | 0.008 | 0.09 | 0.20 | - |
| D | 0.116 | 0.120 | 2.95 | 3.05 | 3 |
| E1 | 0.116 | 0.120 | 2.95 | 3.05 | 4 |
| e | 0.020 BSC |  | 0.50 BSC |  | - |
| E | 0.187 | 0.199 | 4.75 | 5.05 | - |
| L | 0.016 | 0.028 | 0.40 | 0.70 | 6 |
| L1 | 0.037 REF |  | 0.95 REF |  | - |
| N | 10 |  | 10 |  | 7 |
| R | 0.003 | - | 0.07 | - | - |
| R1 | 0.003 | - | 0.07 | - | - |
| $\theta$ | $5^{\circ}$ | $15^{\circ}$ | $5^{0}$ | $15^{\circ}$ | - |
| $\alpha$ | $0^{0}$ | $6^{0}$ | $0^{0}$ | $6^{0}$ | - |

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